



Doc Number:

2001 (14.11.2011
☐ Tentative Specification
☐ Preliminary Specification
Approval Specification

MODEL NO.: R190E6 SUFFIX: L01

Customer:	
APPROVED BY	SIGNATURE
Name / Title Note	
Please return 1 copy for signature and comments.	your confirmation with your

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2011-07-11 13:49:52		yuhsiang.chang (張喻翔/514-10922)	Director	Accept

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REVISION HISTORY

Version	Date	Page	Description
2.0	2011/6/30	All	Approval spec is first released
	2011/7/5		Correct LVDS connector P/N to GS23302-1311S-7F
		8	1. sec.4.1, function block diagram
2.1		9	2. sec.4.2, interface conditions, note(1)
		32	3. appendix : outline drawing

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Global LCD Panel Exchange Center

PRODUCT SPECIFICATION

1. GENERAL DESCRIPTION

1.1 OVERVIEW

R190E6-L01 is an 19.0" TFT Liquid Crystal Display module with 14 CCFL Backlight unit and 30 pins and one port 2ch-LVDS interface. This module supports 1280 x 1024 SXGA mode and displays 16.7M colors driven by 8bit drivers. The LCD module includes built-in inverter for Backlight.

1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note		
Screen Size	19.0" real diagonal				
Driver Element	a-si TFT active matrix	-	-		
Pixel Number	1280(xR,G,B) x 1024	Pixel	-		
Pixel Pitch	0.294 (H) x 0.294 (V)	Mm	-		
Pixel Arrangement	Sub-pixel Vertical stripe		-		
Display Colors	16.7M	color	-		
Transmissive Mode	Dual domain IPS, Normally Black	-	-		
Surface Treatment	AG type	-	-		
Luminance, White	650	Cd/m2	-		
Power Consumption	Total 45.84W (typ.) @ cell 3.84 W (typ.), BL	Total 45.84W (typ.) @ cell 3.84 W (typ.), BL 42 W (typ.)			

Note (1) The specified power consumption: Total= cell (reference 4.3.1)+ BL (reference 4.3.4)

2. MECHANICAL SPECIFICATIONS

It	em	Min.	Тур.	Max.	Unit	Note
	Horizontal (H)	395.5	396	397.5	mm	
Module Size	Vertical (V)	323.5	324	324.5	mm	(1)
	Thickness (T)		27.1	27.6	mm	
Bezel Area	Horizontal	380.0	380.3	380.6	mm	
bezei Alea	Vertical	304.7	305	305.3	mm	
Active Area	Horizontal	-	376.32	-	mm	
Active Area	Vertical	_	301.056	-	mm	
Weight		_	1700	1800	g	

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

3. ABSOLUTE MAXIMUM RATINGS

3.1 ABSOLUTE RATINGS OF ENVIRONMENT

Item	Symbol	Va	lue	Unit	Note	
item	Symbol	Min.	Max.	Offic	Note	
Storage Temperature	TST	-20	60	°C	(1)	
Operating Ambient Temperature	TOP	0	55	°C	(1), (2)	

Note (1)

- (a) 90 %RH Max. (Ta <= 40 °C).
- (b) Wet-bulb temperature should be 39 °C Max. (Ta > 40 °C).
- (c) No condensation.

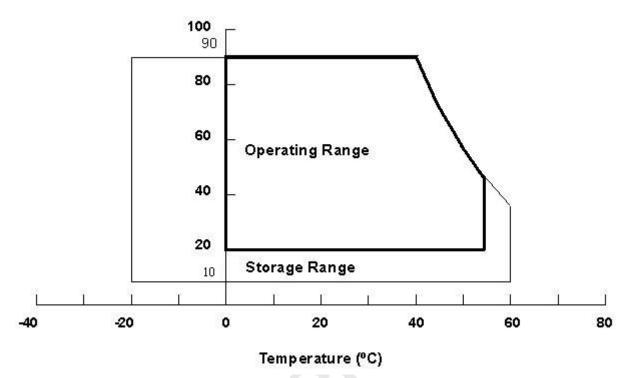
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Note (2) The temperature of panel surface should be 0 °C min. and 60 °C max.

Relative Humidity (%RH)



3.2 ELECTRICAL ABSOLUTE RATINGS

3.2.1 TFT LCD MODULE

Item	Item Symbol		lue	Unit	Note
itom	Cymbol	Min.	Max.	Offic	11010
Power Supply Voltage	vccs	-0.3	13.2	٧	(1)
Logic Input Voltage	V_{IN}	-0.3	4.3	V	(1)

3.2.2 BACKLIGHT UNIT

Item	Symbol		Value			Note	
item	Gyrribor	Min.	Тур	Max.	Unit	14016	
Lamp Voltage	V_L	639	710	781	V_{RMS}		
Lamp current	ΙL	3.7	4.2	4.7	mA_{RMS}	(1), (2)	
Lamp frequency	F_L	40		80	KHz		

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

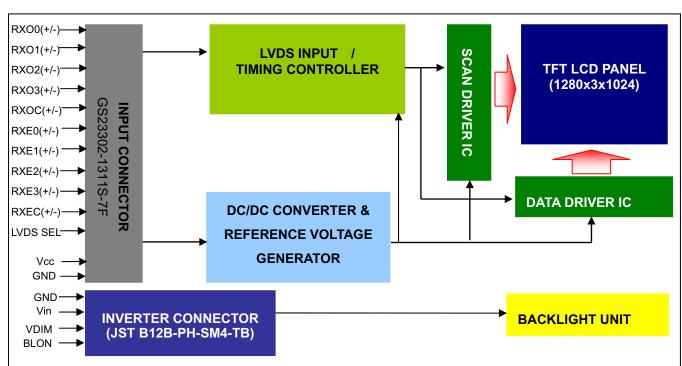
Note (2) Specified values are for lamp (Refer to 4.3.3 and 4.3.4 for further information).





4. ELECTRICAL SPECIFICATIONS

4.1 FUNCTION BLOCK DIAGRAM



4.2. INTERFACE CONNECTIONS

PIN ASSIGNMENT

PIN ASSI	GNIVIENT	
Pin	Name	Description
1	RXO0-	Negative LVDS differential data input. Channel O0 (odd)
2	RXO0+	Positive LVDS differential data input. Channel O0 (odd)
3	RXO1-	Negative LVDS differential data input. Channel O1 (odd)
4	RXO1+	Positive LVDS differential data input. Channel O1 (odd)
5	RXO2-	Negative LVDS differential data input. Channel O2 (odd)
6	RXO2+	Positive LVDS differential data input. Channel O2 (odd)
7	GND	Ground
8	RXOC-	Negative LVDS differential clock input. (odd)
9	RXOC+	Positive LVDS differential clock input. (odd)
10	RXO3-	Negative LVDS differential data input. Channel O3(odd)
11	RXO3+	Positive LVDS differential data input. Channel O3 (odd)
12	RXE0-	Negative LVDS differential data input. Channel E0 (even)
13	RXE0+	Positive LVDS differential data input. Channel E0 (even)
14	GND	Ground
15	RXE1-	Negative LVDS differential data input. Channel E1 (even)
16	RXE1+	Positive LVDS differential data input. Channel E1 (even)
17	GND	Ground
18	RXE2-	Negative LVDS differential data input. Channel E2 (even)
19	RXE2+	Positive LVDS differential data input. Channel E2 (even)
20	RXEC-	Negative LVDS differential clock input. (even)
21	RXEC+	Positive LVDS differential clock input. (even)
22	RXE3-	Negative LVDS differential data input. Channel E3 (even)
23	RXE3+	Positive LVDS differential data input. Channel E3 (even)

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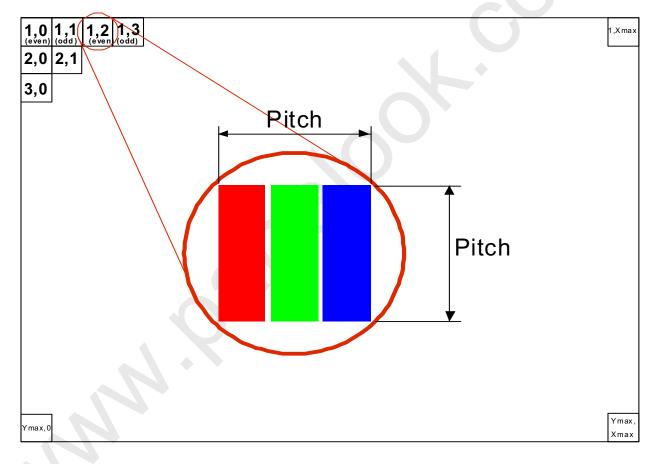
24	GND	Ground
25	LVDS_SEL	0:VESA Mode; 1:JEITA Mode (0 : Ground ; 1 : 3.3V) ; default is zero
26	NC	Not connection, this pin should be open
27	NC	Not connection, this pin should be open
28	V _{CC} (12V)	+12.0V power supply
29	V _{CC} (12V)	+12.0V power supply
30	V _{CC} (12V)	+12.0V power supply

Note (1) Connector Part No.: GS23302-1311S-7F (Foxconn KunShan)

Note (2) The first pixel is even.

Note (3) Input signal of even and odd clock should be the same timing.

Note (4) The module uses a 100-ohm resistor between positive and negative data lines of each receiver input



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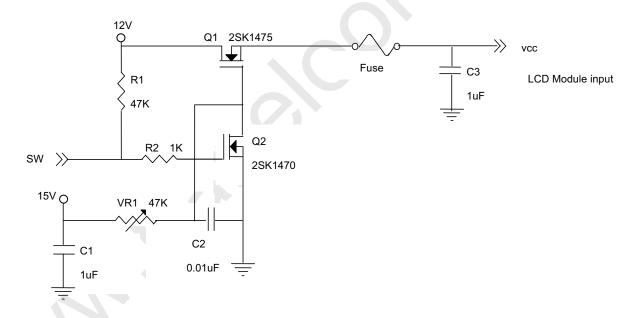
4.3 ELECTRICAL CHARACTERISTICS

4.3.1 LCD ELETRONICS SPECIFICATION

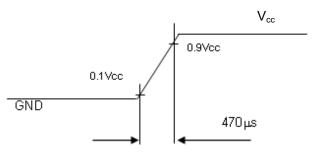
Darama	Parameter					Unit	Note
Falaille	Symbol	Min.	Тур.	Max.	Offic	Note	
Power Supply	Vcc	11.4	12	12.6	V	-	
Ripple Vo	Itage	V_{RP}	-	-	300	mV	-
Rush Cu	rrent	I _{RUSH}	-	-	3	Α	(2)
	White		-	0.410	0.574	Α	(3)a
Power Supply Current	Black		-	0.200	0.280	Α	(3)b
	Vertical Stripe		-	0.350	0.490	Α	(3)c
Power Cons	umption	PLCD	-	4.92	6.888	Watt	(4)
LVDS differential	LVDS differential input voltage			-	600	mV	
LVDS common in	Vic	1.0	1.2	1.4	V		
Logic High Inp	VIH	2.64	-	-	V		
Logic Low Inpu	ut Voltage	VIL	-	-	0.66	V	

Note (1) The ambient temperature is $Ta = 25 \pm 2$ °C.

Note (2) Measurement Conditions:



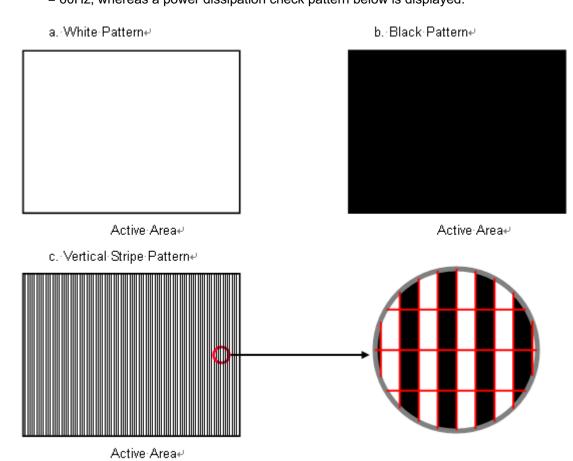
Vcc rising time is 470µs



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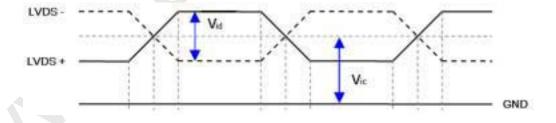


Note (3) The specified power supply current is under the conditions at Vcc =12.0 V, Ta = 25 ± 2 °C, Fr = 60Hz, whereas a power dissipation check pattern below is displayed.



Note (4) The power consumption is specified at the pattern with the maximum current.

Note (5) VID waveform condition

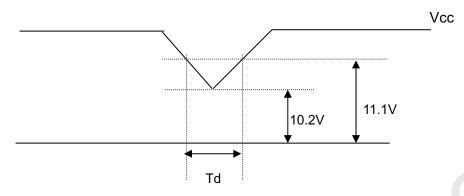


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4.3.2 Vcc Power Dip Condition

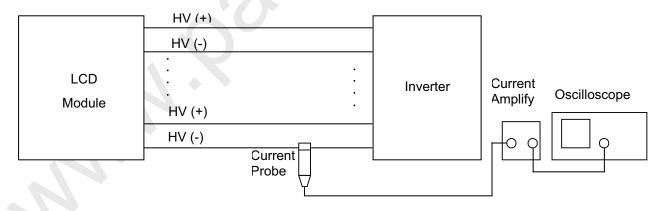


Dip condition: $10.2V \le Vcc \le 11.1V$, $Td \le 20ms$

4.3.3 BACKLIGHT UNIT

Parameter	Symbol		Value	Unit	Note	
i arameter	Symbol	Min. Typ.		Max.	Offic	Note
Lamp Input Voltage	V_L	639	710	781	V_{RMS}	$I_{L} = 4.2 \text{mA}$
Lamp Current	ال	3.7	4.2	4.7	mA_RMS	(1)
Lamp Turn On Voltage	Vs		1065(0 °C)	1330(0 °C)	V_{RMS}	(2)
Lamp rum On voltage	VS		850(25 °C)	1065(25 °C)	V_{RMS}	(2)
Operating Frequency	F_L	40		60	KHz	(3)
Lamp Life Time	L_BL	50,000			Hrs	(4)

Note (1) Lamp current is measured by utilizing high frequency current meters as shown below:



- Note (2) The voltage shown above should be applied to the lamp for more than 1 second after startup.

 Otherwise the lamp may not be turned on.
- Note (3) The lamp frequency may produce interference with horizontal synchronous frequency from the display, and this may cause line flow on the display. In order to avoid interference, the lamp frequency should be detached from the horizontal synchronous frequency and its harmonics as far as possible.

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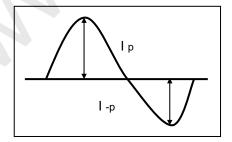


- Note (4) The lifetime of lamp can be defined as the time in which it continues to operate under the condition Ta = 25 ± 2 °C and I_L = 3.7~4.7 mA_{rms} until one of the following events occurs:
 - (a) When the brightness becomes or lower than 50% of its original value.
 - (b) When the effective ignition length becomes lower than 80% of its original value. (Effective ignition length is defined as an area that has less than 70% brightness compared to the brightness in the center point.)
- Note (5) The waveform of the voltage output of inverter must be area-symmetric and the design of the inverter must have specifications for the modularized lamp. The performance of the Backlight, such as lifetime or brightness, is greatly influenced by the characteristics of the DC-AC inverter for the lamp. All the parameters of an inverter should be carefully designed to avoid producing too much current leakage from high voltage output of the inverter. When designing or ordering the inverter please make sure that a poor lighting caused by the mismatch of the Backlight and the inverter (miss-lighting, flicker, etc.) never occurs. If the above situation is confirmed, the module should be operated in the same manners when it is installed in your instrument.

The output of the inverter must have symmetrical (negative and positive) voltage waveform and symmetrical current waveform.(Unsymmetrical ratio is less than 10%) Please do not use the inverter, which has unsymmetrical voltage and unsymmetrical current and spike wave. Lamp frequency may produce interface with horizontal synchronous frequency and as a result this may cause beat on the display. Therefore lamp frequency shall be as away possible from the horizontal synchronous frequency and from its harmonics in order to prevent interference.

Requirements for a system inverter design, which is intended to have a better display performance, a better power efficiency and a more reliable lamp. It shall help increase the lamp lifetime and reduce its leakage current.

- a. The asymmetry rate of the inverter waveform should be 10% below;
- b. The distortion rate of the waveform should be within $\sqrt{2 \pm 10\%}$;
- c. The ideal sine wave form shall be symmetric in positive and negative polarities.



* Asymmetry rate: $|I_{p} - I_{-p}| / I_{rms} * 100\%$ * Distortion rate $I_p (or I_{-p}) / I_{rms}$

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4.3.4 INVERTER ELECTRICAL CHARATERISTIC

Item	Symbol	Description	Min.	Тур.	Max.	Unit
1	V_{in}	Input voltage	11.4	12	12.6	V
2	l _{in}	Input current (@Vin=12V)		3.5		Α
3	P _{in}	Input power		42		W
4	BLON	Inverter On/Off control: OFF	0		0.8	V
4	BLON	Inverter On/Off control: ON	2		5	V
		Output current control				
5	VDIM	VDIM: 0V, maximum brightness	0		3	V
		VDIM: 3V, minimum brightness				
6	F _b	Burst Mode Frequency	150	160	170	Hz
7	Freq.	Operating frequency	52	55	58	KHz
8	l _{out}	Output current, VDIM=0V (high side)	3.7	4.2	4.7	mA

4.3.5 INVERTER INPUT SIGNAL

Pin No.	Symbol	Description
1	Vin	Input voltage
2	Vin	Input voltage
3	Vin	Input voltage
4	Vin	Input voltage
5	Vin	Input voltage
6	Gnd	Ground
7	Gnd	Ground
8	Gnd	Ground
9	Gnd	Ground
10	Gnd	Ground
11	VDIM	Brightness control (0~3V)
12	BLON	Inverter On/Off control (5.0/0V)

Note (1) Connector Part No.: B12B-PH-SM4-TB (JST) or equivalent

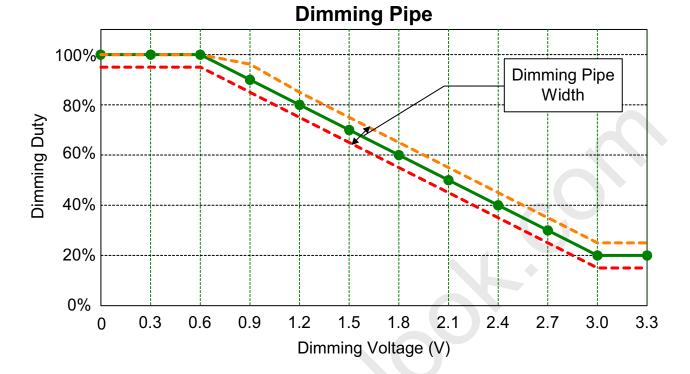
Note (2) User's connector Part No.:→ PHR-12 (JST)

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The following chart is the VDIM vs. Dimming Range for your reference.



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4.4 LVDS INPUT SIGNAL SPECIFICATIONS

4.4.1 LVDS DATA MAPPING TABLE

VESA MODE

LVDS_SEL = Ground or Open									
LVDS Channel O0	LVDS output	D7	D6	D4	D3	D2	D1	D0	
LVD3 Channel Ou	Data order	OG0	OR5	OR4	OR3	OR2	OR1	OR0	
LVDS Channel O1	LVDS output	D18	D15	D14	D13	D12	D9	D8	
LVD3 Channel O1	Data order	OB1	OB0	OG5	OG4	OG3	OG2	OG1	
LVDS Channel O2	LVDS output	D26	D25	D24	D22	D21	D20	D19	
LVD3 Channel 02	Data order	DE	NA	NA	OB5	OB4	OB3	OB2	
LVDS Channel O3	LVDS output	D23	D17	D16	D11	D10	D5	D27	
LVDS Charmer OS	Data order	NA	OB7	OB6	OG7	OG6	OR7	OR6	
LVDS Channel E0	LVDS output	D7	D6	D4	D3	D2	D1	D0	
LVD3 Channel E0	Data order	EG0	ER5	ER4	ER3	ER2	ER1	ER0	
LVDS Channel E1	LVDS output	D18	D15	D14	D13	D12	D9	D8	
LVD3 Channel E1	Data order	EB1	EB0	EG5	EG4	EG3	EG2	EG1	
LVDS Channel E2	LVDS output	D26	D25	D24	D22	D21	D20	D19	
LVD3 Challiel E2	Data order	DE	NA	NA	EB5	EB4	EB3	EB2	
LVDS Channel E3	LVDS output	D23	D17	D16	D11	D10	D5	D27	
LVD3 Channel E3	Data order	NΔ	FR7	FB6	FG7	FG6	FR7	FR6	

JEITA MODE

LITA WIODE								
LVDS_SEL = 3.3V								
LVDS Channel O0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 Channel Ou	Data order	OG2	OR7	OR6	OR5	OR4	OR3	OR2
LVDS Channel O1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 Channel OT	Data order	OB3	OB2	OG7	OG6	OG5	OG4	OG3
LVDS Channel O2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 Channel 02	Data order	DE	NA	NA	OB7	OB6	OB5	OB4
LVDS Channel O3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 Channel O3	Data order	NA	OB1	OB0	OG1	OG0	OR1	OR0
LVDS Channel E0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 Chaillei Eu	Data order	EG2	ER7	ER6	ER5	ER4	ER3	ER2
LVDS Channel E1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 Channel E1	Data order	EB3	EB2	EG7	EG6	EG5	EG4	EG3
LVDS Channel E2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 Channel E2	Data order	DE	NA	NA	EB7	EB6	EB5	EB4
LVDS Channel E3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 Challiel E3	Data order	NA	EB1	EB0	EG1	EG0	ER1	ER0

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PRODUCT SPECIFICATION

4.4.2 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of color versus data input.

												Da	ta S	Sign	al										
	Color				Re	ed							Gr	een							Blu	ле			
	_	R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Red(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	÷		÷	•	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	•			:	:	:	:	:	:	:	:	:	:
Red	Red(253)	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
1.00	Red(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
Gray	Green(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:		4):	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	-					:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Green	Green(253)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
	Green(254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Green(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
Gray	Blue(2)	0 <	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Scale	:	:		\vdots	/ :	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	: (250)	:			:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Blue	Blue(253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
•	Blue(254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage





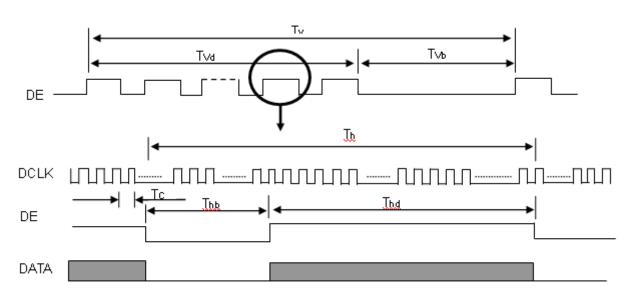
4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note
	Frequency	F_c	45.74	54	75.03	MHz	-
	Period	T _c	13.33	18.5	21.86	ns	
	Input cycle to cycle jitter	T_{rcl}	-0.02*Tc	I	0.02*Tc	ns	(1)
	Input Clock to data skew	TLVCCS			400	ps	(2)
LVDS Clock	Spread spectrum modulation range	Fclkin_ mod	0.97*Fc		1.03*Fc	MHz	(2)
	Spread spectrum modulation frequency	F _{SSM}			200	KHz	(3)
	Frame Rate	F _r	56	60	75	Hz	$T_v = T_{vd} + T_{vb}$
	Total	T_v	1034	1066	1124	Th	-
Vertical Display Term	Active Display	T_{vd}	1024	1024	1024	Th	-
	Blank	T_{vb}	$T_{v}-T_{vd}$	42	T_{v} - T_{vd}	Th	-
	Total	T_h	790	844	890	Tc	$T_h = T_{hd} + T_{hb}$
Horizontal Display Term	Active Display	T_{hd}	640	640	640	Тс	-
	Blank	T_hb	T_h-T_{hd}	204	T_h - T_{hd}	Tc	-

Note: Because this module is operated by DE only mode, H_{sync} and V_{sync} input signals should be set to low logic level or ground. Otherwise, this module would operate abnormally.

INPUT SIGNAL TIMING DIAGRAM

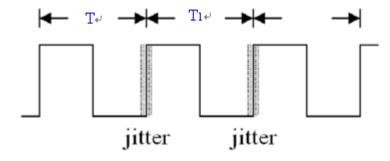


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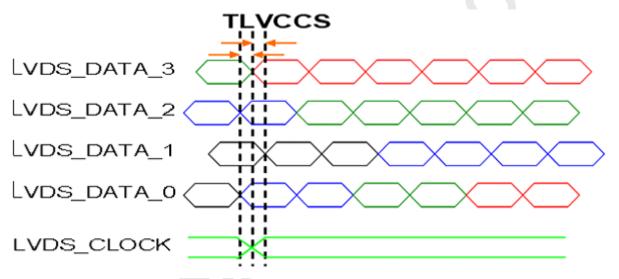




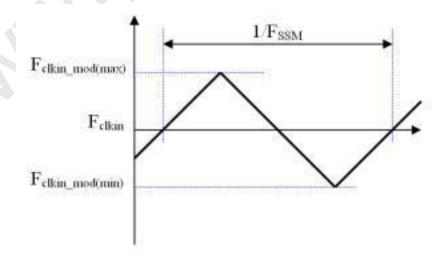
Note (1) The input clock cycle-to-cycle jitter is defined as below figures. Trcl = I $T_1 - TI$



Note (2) Input Clock to data skew is defined as below figures.



Note (3) The SSCG (Spread spectrum clock generator) is defined as below figures.



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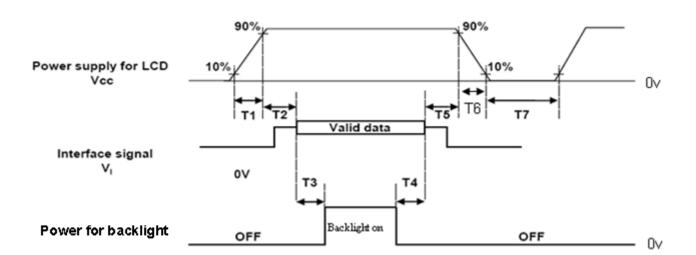




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4.6 POWER ON/OFF SEQUENCE

The power sequence specifications are shown as the following table and diagram.



Timing Specifications:

Parameters		Units		
i arameters	Min	Тур.	Max	Office
T1	0.5	-	10	ms
T2	0	- /	50	ms
T3	450	-	ı	ms
T4	90	-	-	ms
T5	0	-	50	ms
T6	5	-	100	ms
T7	500	-	-	ms

Note.

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- (1) The supply voltage of the external system for the module input should be the same as the definition of Vcc.
- (2) Apply the lamp voltage within the LCD operation range. When the backlight turns on before the LCD operation of the LCD turns off before the backlight turns off, the display may momentarily become abnormal screen.
- (3) In case of V_{CC} = off level, please keep the level of input signals on the low or keep a high impedance.
- (4) T7 should be measured after the module has been fully discharged between power of and on
- (5) Interface signal shall not be kept at high impedance when the power is on.
- (6) It is not guaranteed that products are damaged which is caused by not following the Power Sequence.
- (7) It is suggested that Vcc falling time follows T6 specification; else slight noise is likely to occur when LCD is turned off (even backlight is already off).





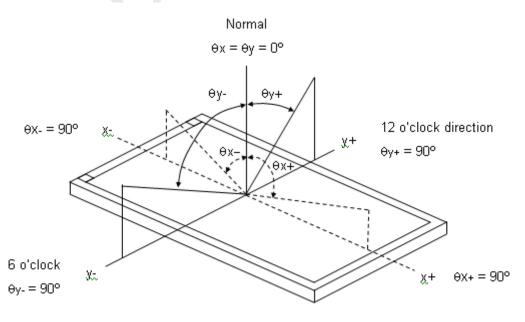
5. OPTICAL CHARACTERISTICS

5.1 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown in 5.1. The following items should be measured under the test conditions described in 5.1 and stable environment shown in Note (5).

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Note
	Red	R _x			0.640			
		R _y			0.330			
Color	Green	G _x		Тур	0.298			
Chromaticity		G _y			0.600	Typ.+	-	(1), (5)
(CIE 1931)	Blue	B_x	θ_x =0°, θ_Y =0°	0.03	0.150	0.03		('), ()
(5.2.55.)	ыйе	B _y	CS-1000T		0.060			
	White	W_x			0.313			
	vviiite	W_y			0.329			
Center Luminan	ce of White	L _C	4	550	650		cd/m ²	(4), (5)
Contrast Ratio		CR		700	900		-	(2), (5)
Response Time		T_R	$\theta_x=0^\circ$, $\theta_Y=0^\circ$		15	25	ms	(3)
response nine		T_F	θ_{x} -0, θ_{Y} -0		10	15	ms	(3)
White Variation(a	adjacent)	δW_a	θ_x =0°, θ_Y =0° USB2000	90			-	(5), (6)
White Variation(t	White Variation(total)		θ_x =0°, θ_Y =0° USB2000	70			-	(5), (6)
		Θ_{y+}		80	88			
Viewing Angle		⊖ _{y-}	CR ≥ 10	80	88		Das	(4) (5)
	0 0		USB2000	80	88		Deg.	(1), (5)
		⊖ _{x-}		80	88			

Note (1)Definition of Viewing Angle (θx , θy):



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Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L255 / L0

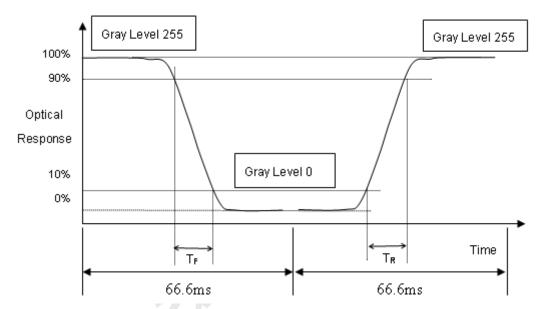
L255: Luminance of gray level 255

L 0: Luminance of gray level 0

CR = CR (5)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (4).

Note (3) Definition of Response Time (T_R, T_F) :



Note (4) Definition of Luminance of White (L_C):

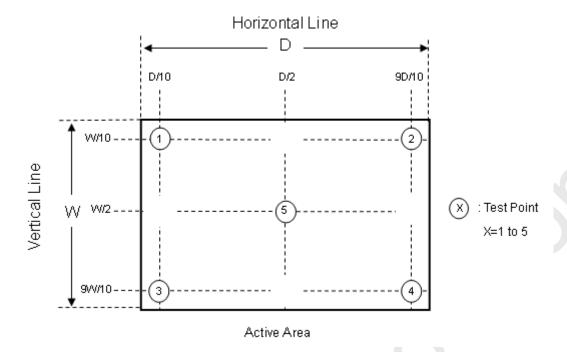
Measure the luminance of gray level 255 at center point

$$L_{C} = L (5)$$

 $L\left(x\right)$ is corresponding to the luminance of the point X at the following figure.







Note (5) Measurement Setup:

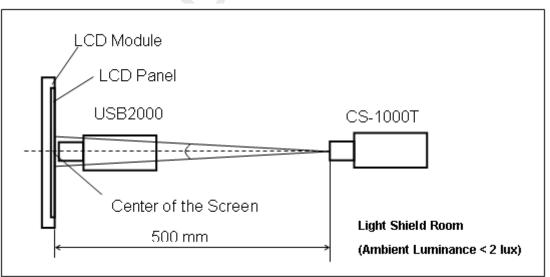
The LCD module should be stabilized at given temperature for 60 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 60 minutes in a windless room.

Unless otherwise specified, the ambient conditions are as following.

Ambient Temperature: 25 ± 2 (degreeC)

Ambient Humidity: 25 ~ 85 (%)

Atmospheric Pressure: $86.0 \sim 104.0 \text{ (kP}_a)$



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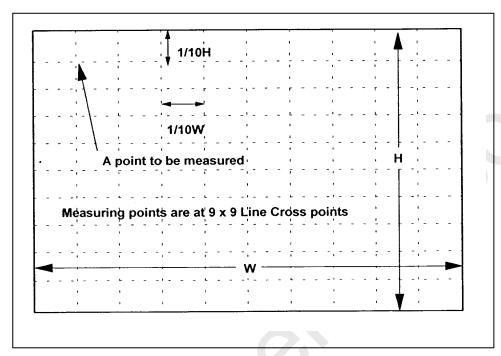
PRODUCT SPECIFICATION

Note (6) There is the Uniformity Measurement below:

'L_{bright}' represents the Luminance of the point that is brighter than the other point to be compared.

'Ldark' represents the Luminance of the point that is darker than the other point to be compared.

Measuring points are shown in the following Fig.



When the backlight is on with all pixels in the white (maximum gray) level, the luminance uniformity is defined as follows;

Where:

L_{bright}: The luminance of the brightness part of the area

L_{dark}: The luminance of the darkest part of the area

1. Adjacent Area

Luminance Uniformity =
$$\frac{L_{dark}}{L_{bright}} \ge 0.90$$

over a circular area of 10mm diameter placed anywhere on the screen.

2. Screen Total

Luminance Uniformity =
$$\frac{L_{dark}}{L_{bright}} \ge 0.70$$

over the entire screen.

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6. RELIABILITY TEST ITEM

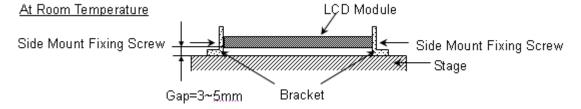
Items	Required Condition	Note
Temperature Humidity Bias (THB)	Ta= 50℃,80%RH, 240hours	
High Temperature Operation (HTO)	Ta= 55℃, 240hours	
Low Temperature Operation (LTO)	Ta= 0℃ , 240hours	
High Temperature Storage (HTS)	Ta= 60℃ , 240hours	
Low Temperature Storage (LTS)	Ta= -20°C , 240hours	
Vibration Test (Non-operation)	Acceleration: 1.5 G _{rms} Wave: Half-sine Frequency: 10 - 300 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 11 ms Direction: ± X, ± Y, ± Z.(one time for each Axis)	
Thermal Shock Test (TST)	-20 $^{\circ}$ C/30min , 60 $^{\circ}$ C / 30min , 100 cycles	
ESD (Electro Static Discharge)	Contact Discharge: ± 8KV, 150pF(330Ω)	
	Air Discharge: ± 15KV, 150pF(330Ω)	

Note (1) criteria: Normal display image with no obvious non-uniformity and no line defect.

Note (2) Evaluation should be tested after storage at room temperature for more than two hour

Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.

The fixing condition is shown as below:







7. PACKING

7.1 PACKING SPECIFICATIONS

(1) 5 LCD modules / 1 Box

(2) Box dimensions: 485(L) X 365(W) X 430(H) mm

(3) Weight: approximately: 11.75kg (5 modules per box)

7.2 PACKING METHOD

(1) Carton Packing should have no failure in the following reliability test items.

Test Item	Test Conditions	Note
	ISTA STANDARD	
Vibration	Random, Frequency Range: 1 – 200 Hz	
	Top & Bottom: 30 minutes (+Z), 10 min (-Z),	Non Operation
	Right & Left: 10 minutes (X)	
	Back & Forth 10 minutes (Y)	
Dropping Test	1 Corner, 3 Edge, 6 Face, 61cm	Non Operation

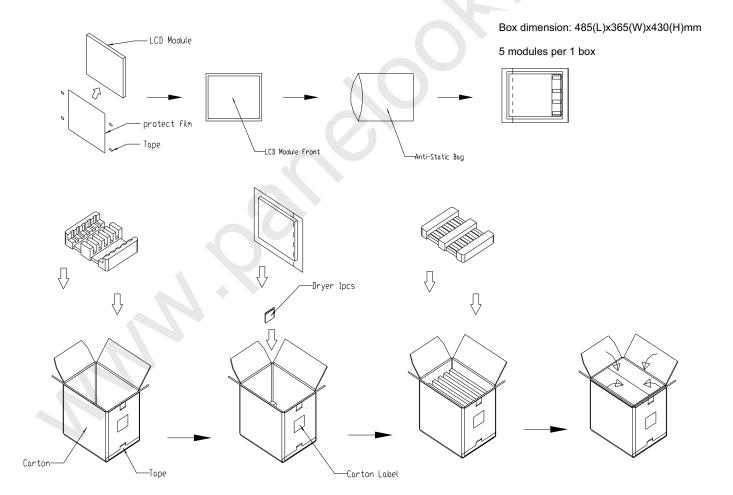


Figure. 7-1 Packing method

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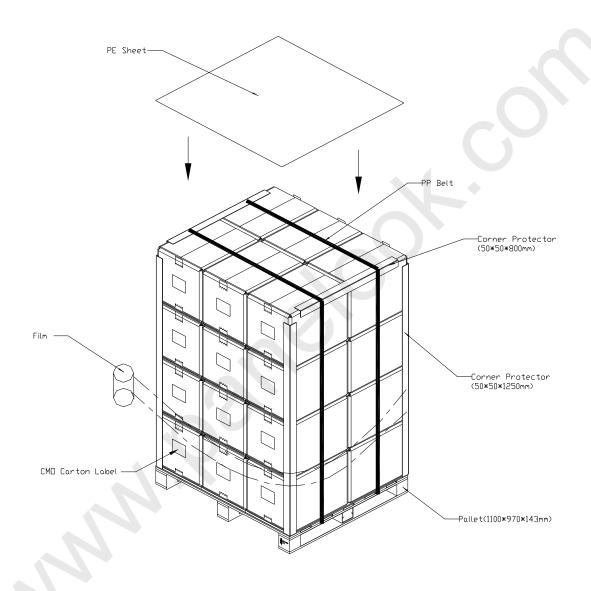




7.3 PALLET

For ocean shipping

Sea and land transportation



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For air transport

Air transportation

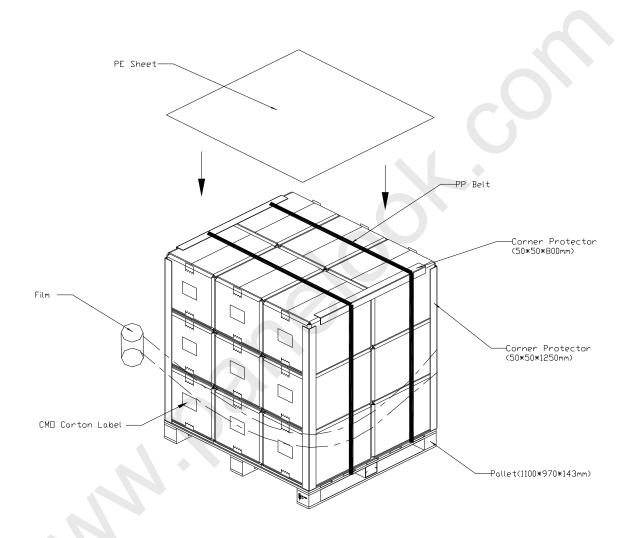


Figure. 7-2 Packing method

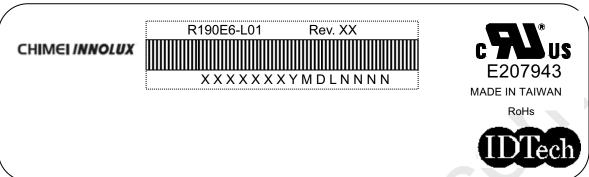
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8. CMI MODULE LABEL

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



(a) Model Name: R190E6-L01

(b) Revision: Rev. XX, for example: A0, A1... B1, B2... or C1, C2...etc.

(c) CMI barcode definition:

Serial ID: XX-XX-XX-YMD-L-NNNN

Code	Meaning	Description
XX	CMI internal use	-
XX	Revision	Cover all the change
Х	CMI internal use	-
XX	CMI internal use	-
YMD	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=32010=0, 2011=1, 2012=2 Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, W, X, Y, exclude I, O, and U.
L	Product line # Line 1=1, Line 2=2, Line 3=3,	
NNNN	Serial number	Manufacturing sequence of product





9. PRECAUTIONS

9.1 ASSEMBLY AND HANDLING PRECAUTIONS

- (1) Do not apply rough force such as bending or twisting to the module during assembly.
- (2) To assemble or install module into user's system can be only in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.
- (3) It's not permitted to have pressure or impulse on the module because the LCD panel and Backlight will be damaged.
- (4) Always follow the correct power sequence when LCD module is connecting and operating. This can prevent damage to the CMOS LSI chips during latch-up.
- (5) Do not pull the I/F connector in or out while the module is operating.
- (6) Do not disassemble the module.
- (7) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.
- (8) It is dangerous that moisture come into or contacted the LCD module, because moisture may damage LCD module when it is operating.
- (9) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (10)When ambient temperature is lower than 10°C may reduce the display quality. For example, the response time will become slowly.

9.2 STORAGE PRECAUTIONS

- (1) Do not leave the module in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0° C to 35° C and relative humidity of less than 70%
- (2) Do not store the TFT LCD module in direct sunlight
- (3) The module should be stored in dark place. It is prohibited to apply sunlight or fluorescent light in storing

9.3 OPERATION PRECAUTIONS

(1) The LCD product should be operated under normal condition.

Normal condition is defined as below:

Temperature : 20±15℃ Humidity: 65±20%

Display pattern: continually changing pattern (Not stationary)

(2) If the product will be used in extreme conditions such as high temperature, high humidity, high altitude ,display pattern or operation time etc...It is strongly recommended to contact CMO for application engineering advice. Otherwise, Its reliability and function may not be guaranteed.

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9.4 SAFETY PRECAUTIONS

- (1) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- (2) After the module's end of life, it is not harmful in case of normal operation and storage.

9.5 SAFETY STANDARDS

The LCD module should be certified with safety regulations as follows:

- (1) UL60950-1 or updated standard.
- (2) IEC60950-1 or updated standard.

9.6 OTHER

When fixed patterns are displayed for a long time, remnant image is likely to occur.

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